

L Number	Hits	Search Text	DB	Time stamp
1	676	438/398.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 20:02
2	32	438/398.ccls. and (metal near12 (textur\$3 texturi\$4 rough roughen\$3 bump hump (surface adj area)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 20:47
3	219	438/677.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 20:38
4	19	438/677.ccls. and (metal near12 (textur\$3 texturi\$4 rough roughen\$3 bump hump (surface adj area)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 20:42
5	23746	(retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near6 (seed\$3 nuclei nucleat\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 21:03
6	1030	((retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near6 (seed\$3 nuclei nucleat\$3)) near12 (halogen halide chlori?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "ClF.sub.3")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 21:03
7	6	((retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near6 (seed\$3 nuclei nucleat\$3)) near12 (halogen halide chlori?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "ClF.sub.3")) and (metal near12 (textur\$3 texturi\$4 rough roughen\$3 bump hump (surface adj area)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 21:04
8	37683	(retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near6 (ammonia "NH.sub.3")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 20:53
9	46	((retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near6 (seed\$3 nuclei nucleat\$3)) near12 (halogen halide chlori?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "ClF.sub.3")) and ((retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near6 (ammonia "NH.sub.3"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 20:49
10	461	(retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near6 ((ammonia "NH.sub.3") near4 (deposit\$3 adsorp\$4 adher\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 20:54
11	18	((retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near6 ((ammonia "NH.sub.3") near4 (deposit\$3 adsorp\$4 adher\$3))) same (W WN WN?sub.? tungsten)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 21:05
12	30044	(retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near10 (seed\$3 nuclei nucleat\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 21:03

13	1466	((retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near10 (seed\$3 nuclei nucleat\$3)) near12 (halogen halide chlori?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "CIF.sub.3"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 21:03
14	11	((retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near10 (seed\$3 nuclei nucleat\$3)) near12 (halogen halide chlori?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "CIF.sub.3")) and (metal near12 (textur\$3 texturi\$4 rough roughen\$3 bump hump (surface adj area)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 21:04
15	20253	deposit\$3 near5 (W WN WN?sub.? tungsten)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 21:06
16	10032	(deposit\$3 near5 (W WN WN?sub.? tungsten)) and ((pretreat\$4 treat\$3 expos\$3 preparation preperatory prepar\$3) near12 (surface dielectric insulat\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 21:08
17	473	(deposit\$3 near5 (W WN WN?sub.? tungsten)) and ((pretreat\$4 treat\$3 expos\$3 preparation preperatory prepar\$3) near12 (surface dielectric insulat\$3) near20 (halogen halide chlori?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "CIF.sub.3"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 21:09
18	144	(deposit\$3 near5 (W WN WN?sub.? tungsten)) and ((pretreat\$4 treat\$3 expos\$3 preparation preperatory prepar\$3) near12 (dielectric insulat\$3) near20 (halogen halide chlori?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "CIF.sub.3"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/12 21:09
19	16	4552783.URPN.	USPAT	2003/12/12 21:13
20	3	5502005.URPN.	USPAT	2003/12/12 21:36